

STFW3N170

N-channel 1700 V, 7 Ω typ., 2.6 A PowerMESH™ Power MOSFET in a TO-3PF package

Datasheet - production data

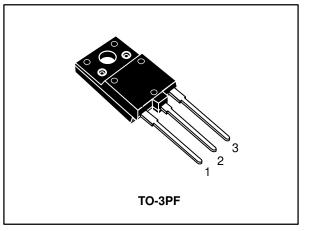
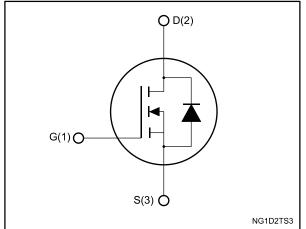


Figure 1: Internal schematic diagram



Features

Order code	VDS	RDS(on) max.	ID	Ртот
STFW3N170	1700 V	13 Ω	2.6 A	63 W

- Intrinsic capacitances and Qg minimized
- TO-3PF for higher creepage between leads
- High speed switching
- 100% avalanche tested

Applications

• Switching applications

Description

This Power MOSFET is designed using the STMicroelectronics consolidated strip-layoutbased MESH OVERLAY™ process. The result is a product that matches or improves on the performance of comparable standard parts from other manufacturers.

Table 1: Device summary

Order code	Marking	Package	Packing
STFW3N170	3N170	TO-3PF	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VDS	Drain-source voltage	1700	V
V _{GS}	Gate-source voltage	±30	V
D ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	2.6	٨
ID(*/	Drain current (continuous) at T _{case} = 100 °C	1.6	A
I _{DM}	Drain current (pulsed)	10.4	А
Ртот	Total dissipation at T _{case} = 25 °C	63	W
l _{ar}	Avalanche current, repetitive or not repetitive	0.8	А
E _{AS} ⁽²⁾	Single pulse avalanche energy	2	mJ
Viso	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	3.5	kV
T _{stg}	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature		-0

Notes:

⁽¹⁾ Limited by maximum junction temperature.

 $^{(2)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	2	°C/W
Rthj-amb	Thermal resistance junction-ambient	50	C/W



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	1700			V
	Zoro goto voltago drain	$V_{GS} = 0 V, V_{DS} = 1700 V$			10	
IDSS	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 1700 V, T _{case} = 125 °C			500	μA
Igss	Gate-body leakage current	$V_{\text{DS}} = 0 \text{ V}, \text{ V}_{\text{GS}} = \pm 30 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \; \mu A$	3	4	5	٧
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.3 \text{ A}$		7	13	Ω

Table 5. Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1100	-	
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	50	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	7	-	P
Rg	Intrinsic gate resistance	Intrinsic gate resistance $f = 1 \text{ MHz}, I_D = 0 \text{ A}$		3.6	-	Ω
Qg	Total gate charge $V_{DD} = 1360 \text{ V}, I_D = 2.6 \text{ A},$		-	44	-	
Qgs	Gate-source charge	charge V _{GS} = 10 V (see <i>Figure</i> 15: "Gate charge test		7	-	nC
Q _{gd}	Gate-drain charge	circuit")	-	25	-	

Table 5: Dynamic

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(on)	Turn-on delay time	$V_{DD} = 850 \text{ V}, \text{ I}_{D} = 1.3 \text{ A}$	-	25	-	
tr	Rise time	R _G = 4.7 Ω, V _{GS} = 10 V (see <i>Figure 14:</i>	-	9	-	
td(off)	Turn-off delay time	"Switching times test	-	51	-	ns
tr	Fall time	circuit for resistive load" and Figure 19: "Switching time waveform")	-	53	-	

Electrical characteristics

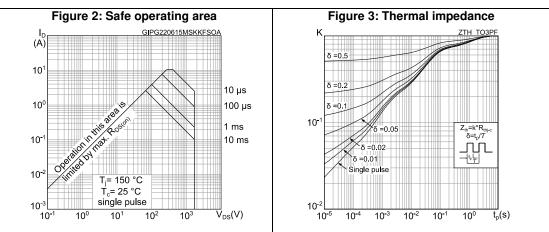
Table 7: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		2.6	
Isdm	Source-drain current (pulsed)	T _j = 25 °C	-		10.4	A
Vsd ⁽¹⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 2.6 A$	-		1.5	V
trr	Reverse recovery time	I _{SD} = 2.6 A,	-	1.58		μs
Qrr	Reverse recovery charge	di/dt = 100 A/µs, V _{DD} = 60 V (see <i>Figure</i>	-	6		μC
Irrm	Reverse recovery current	16: "Test circuit for inductive load switching and diode recovery times")	-	7.9		A
trr	Reverse recovery time	I _{SD} = 2.6 A,	-	2.12		μs
Qrr	Reverse recovery charge	di/dt = 100 A/µs, V _{DD} = 60 V, T _i = 150 °C	-	8.8		μC
Irrm	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	8.3		A

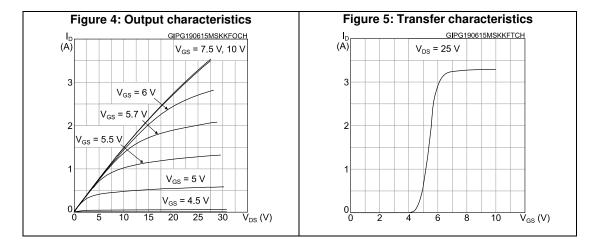
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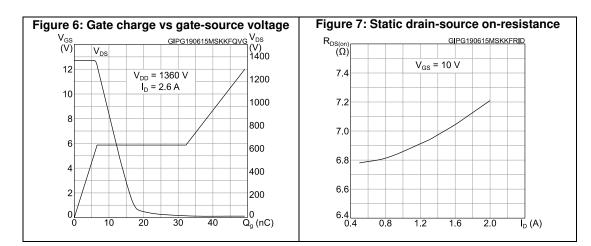
 $^{(1)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



2.1 Electrical characteristics (curves)



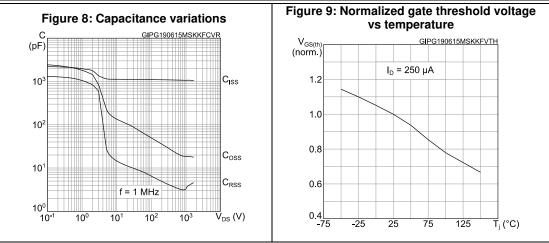


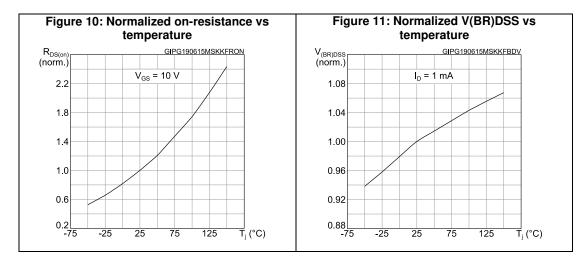


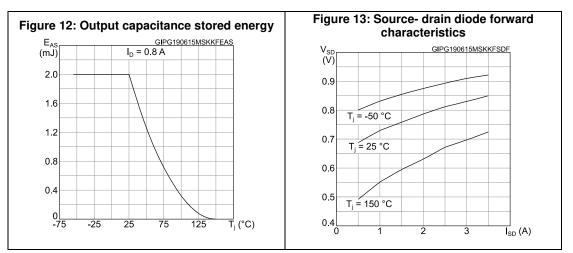
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Electrical characteristics



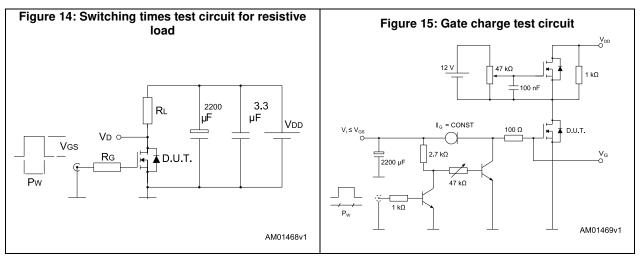


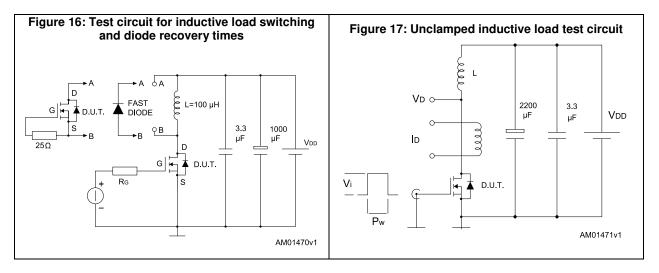


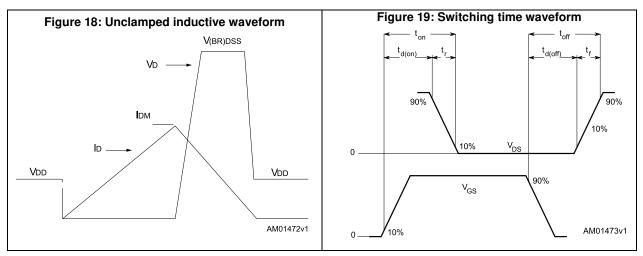
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3 Test circuits





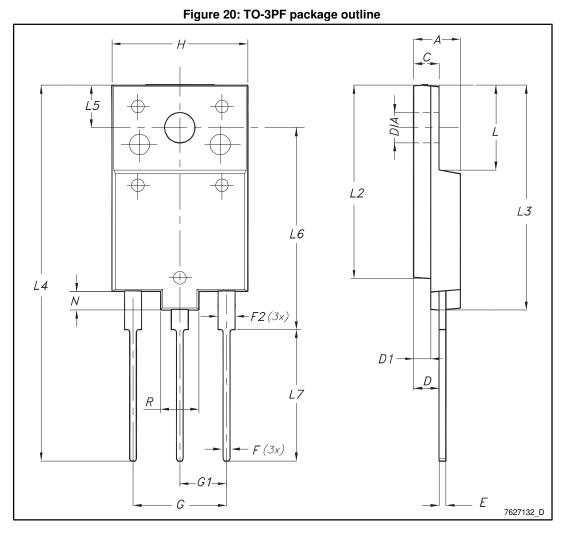


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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-3PF package information





Package information

STFW3N170

Table 8: TO-3PF mechanical data			
Dim.		mm	
Dim.	Min.	Тур.	Max.
A	5.30		5.70
С	2.80		3.20
D	3.10		3.50
D1	1.80		2.20
E	0.80		1.10
F	0.65		0.95
F2	1.80		2.20
G	10.30		11.50
G1		5.45	
Н	15.30		15.70
L	9.80	10	10.20
L2	22.80		23.20
L3	26.30		26.70
L4	43.20		44.40
L5	4.30		4.70
L6	24.30		24.70
L7	14.60		15
N	1.80		2.20
R	3.80		4.20
Dia	3.40		3.80

5 Revision history

Table 9: Document revision history

Date	Revisi on	Changes
17-Jan-2013	1	First release.
22-Jun-2015	2	Text and formatting changes throughout document. Part number STW3N170 has been moved to a separate document. In section Electrical ratings: - updated Table Absolute maximum ratings In section Electrical characteristics: - renamed Table Static (was On/off states) - updated Table Dynamic - updated Table Dynamic - updated Table Switching times - updated Table Source-drain diode Added section Electrical characteristics (curves) In section Package information: - updated section name (was Package mechanical data) - updated TO-3PF package information
16-Sep-2015	3	In section <i>Electrical ratings</i> : - updated table <i>Absolute maximum ratings</i> In section <i>Electrical characteristics</i> : - updated table <i>Dynamic</i> In section <i>Electrical characteristics (curves)</i> : - updated figures <i>Thermal impedance</i> and <i>Output capacitance stored</i> <i>energy</i>



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